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CONFIRMATION NO. 7266

Bib Data Sheet

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|-----------------------------|---------------------------------------|--------------|------------------------|---|
| SERIAL NUMBER 10/692,065 | FILING DATE 10/23/2003 RULE | CLASS 257 | GROUP ART UNIT 2818 | ATTORNEY DOCKET NO. YOR920010216US2 |
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APPLICANTS

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** CONTINUING DATA *****

This application is a CON of 10/052,620 01/18/2002 PAT 6,661,098

** FOREIGN APPLICATIONS *****

NONE ON

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 01/28/2004

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|---|---------------------------|------------------------|-----------------------|----------------------------|
| Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no | STATE OR COUNTRY NY | SHEETS DRAWING 3 | TOTAL CLAIMS 20 | INDEPENDENT CLAIMS 4 |
| 35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance | | | | |
| Verified and Acknowledged Examiner's Signature _____ Initials _____ | | | | |

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TITLE

High density area array solder microjoining interconnect structure and fabrication method

☐ All Fees☐ 1.16 Fees (Filing)